

QFN Packaged, $\pm 15\text{kV}$ ESD Protected, +2.7V to +5.5V, 10Nanoamp, 250kbps/ 1Mbps, RS-232 Transceivers with Enhanced Automatic Powerdown

The Intersil ISL4238E/44E/45E devices are 2.7V to 5.5V powered RS-232 transmitters/receivers which meet EIA/TIA-232 and V.28/V.24 specifications, even at $V_{CC} = 3.0\text{V}$. Additionally, they provide $\pm 15\text{kV}$ ESD protection (IEC6100-4-2 Air Gap and Human Body Model) on transmitter outputs and receiver inputs (RS-232 pins). Targeted applications are PDAs, Palmtops, and notebook and laptop computers where the low operational, and even lower standby, power consumption is critical. Efficient on-chip charge pumps, coupled with manual and enhanced automatic powerdown functions, reduce the standby supply current to a 10nA trickle. Tiny 5mm x 5mm **Quad Flat No-Lead** (QFN) packaging and the use of small, low value capacitors ensure board space savings as well. Data rates greater than 250kbps (ISL4238E/44E)/1Mbps (ISL4245E) are guaranteed at worst case load conditions.

The ISL424XE are 3 driver, 5 receiver (DTE) devices that, coupled with the QFN package, provide the industry's smallest, lowest power complete serial port suitable for PDAs, and laptop or notebook computers. The 5x5 QFN requires 60% less board area than a 28 lead TSSOP, and is nearly 20% thinner. The devices also include a noninverting always-active receiver for "wake-up" capability.

The ISL4238E is a 5 driver, 3 receiver device optimized for DCE applications with full hardware handshaking. It also includes a noninverting always-active receiver for RING INDICATOR monitoring. Transmitter and logic inputs include active feedback resistors that retain the input state once driven to a valid logic level.

These devices feature an **enhanced automatic powerdown** function which powers down the on-chip power-supply and driver circuits. This occurs when all receiver and transmitter inputs detect no signal transitions for a period of 30sec. These devices power back up, automatically, whenever they sense a transition on any transmitter or receiver input.

Table 1 summarizes the features of the ISL4238E/4XE, while Application Note AN9863 summarizes the features of each device comprising the 3V RS-232 family.

Features

- Parameters Fully Specified for 10% Tolerance Supplies and Full Industrial Temp Range
- Available in Small QFN (5mm x 5mm) Package which is 60% Smaller than a 28 Lead TSSOP
- ESD Protection for RS-232 I/O Pins to $\pm 15\text{kV}$ (IEC6100)
- DTE (ISL4244E/45E) and DCE (ISL4238E) Versions
- Lowest Supply Current in Powerdown 10nA
- Active Feedback Resistors on T_X and Logic Inputs (ISL4238E)
- Flow Through Pinouts
- Manual and Enhanced Automatic Powerdown Features
- Guaranteed Minimum Data Rate
250kbps (ISL4238E/44E) / 1Mbps (ISL4245E)
- Latch-Up Free
- On-Chip Charge Pumps Require Only Four External 0.1 μF Capacitors
- Wide Power Supply Range. Single +2.7V to +5.5V
- Meets EIA/TIA-232 and V.28/V.24 Specifications at 3V
- RS-232 Compatible with $V_{CC} = 2.7\text{V}$
- Pb-free Available as an Option

Applications

- Any Space Constrained System Requiring RS-232 Ports
 - Battery Powered, Hand-Held, and Portable Equipment
 - Laptop Computers, Notebooks
 - PDAs and Palmtops, Data Cables
 - Cellular/Mobile Phones, Digital Cameras, GPS Receivers

Related Literature

- Technical Brief TB363 "Guidelines for Handling and Processing Moisture Sensitive Surface Mount Devices"
- Technical Brief TB379 "Thermal Characterization of Packages for ICs"
- Technical Brief TB389 "PCB Land Pattern Design and Surface Mount Guidelines for QFN Packages"



ISL4238E, ISL4244E, ISL4245E

TABLE 1. SUMMARY OF FEATURES

PART NUMBER	NO. OF Tx.	NO. OF Rx.	CONFIG.	QFN PKG.	NO. OF MONITOR Rx. (R _{OUTB})	DATA RATE (kbps)	Rx. ENABLE FUNCTION?	MANUAL POWER-DOWN?	ENHANCED AUTOMATIC POWERDOWN FUNCTION?
ISL4238E	5	3	DCE	5x5	1	250	NO	YES	YES
ISL4244E	3	5	DTE	5x5	1	250	NO	YES	YES
ISL4245E	3	5	DTE	5x5	1	1000	NO	YES	YES

Ordering Information

PART NO. (BRAND)	TEMP. RANGE (°C)	PACKAGE	PKG. DWG. #
ISL4238EIR (4238EIR)	-40 to 85	32 Ld QFN	L32.5x5
ISL4238EIRZ (4238EIR) (Note)	-40 to 85	32 Ld QFN (Pb-free)	L32.5x5
ISL4238EIR-T (4238EIR)	-40 to 85	Tape & Reel	L32.5x5
ISL4238EIRZ-T (4238EIR) (Note)	-40 to 85	Tape & Reel (Pb-free)	L32.5x5
ISL4244EIR (4244EIR)	-40 to 85	32 Ld QFN	L32.5x5
ISL4244EIRZ (4244EIR) (Note)	-40 to 85	32 Ld QFN (Pb-free)	L32.5x5
ISL4244EIR-T (4244EIR)	-40 to 85	Tape & Reel	L32.5x5
ISL4244EIRZ-T (4244EIR) (Note)	-40 to 85	Tape & Reel (Pb-free)	L32.5x5

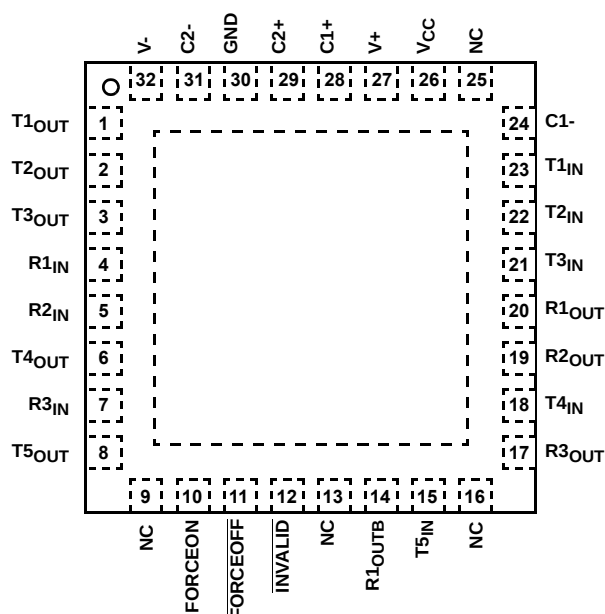
Ordering Information (Continued)

PART NO. (BRAND)	TEMP. RANGE (°C)	PACKAGE	PKG. DWG. #
ISL4245EIR (4245EIR)	-40 to 85	32 Ld QFN	L32.5x5
ISL4245EIRZ (4245EIR) (Note)	-40 to 85	32 Ld QFN (Pb-free)	L32.5x5
ISL4245EIR-T (4245EIR)	-40 to 85	Tape & Reel	L32.5x5
ISL4245EIRZ-T (4245EIR) (Note)	-40 to 85	Tape & Reel (Pb-free)	L32.5x5

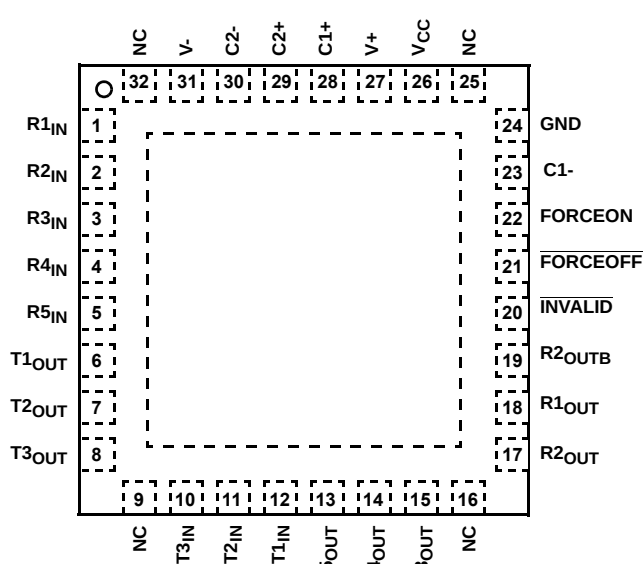
NOTE: Intersil Pb-free products employ special Pb-free material sets; molding compounds/die attach materials and 100% matte tin plate termination finish, which is compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J Std-020B.

Pinouts

ISL4238E (QFN)
TOP VIEW



ISL4244E, ISL4245E (QFN)
TOP VIEW



ISL4238E, ISL4244E, ISL4245E

Pin Descriptions

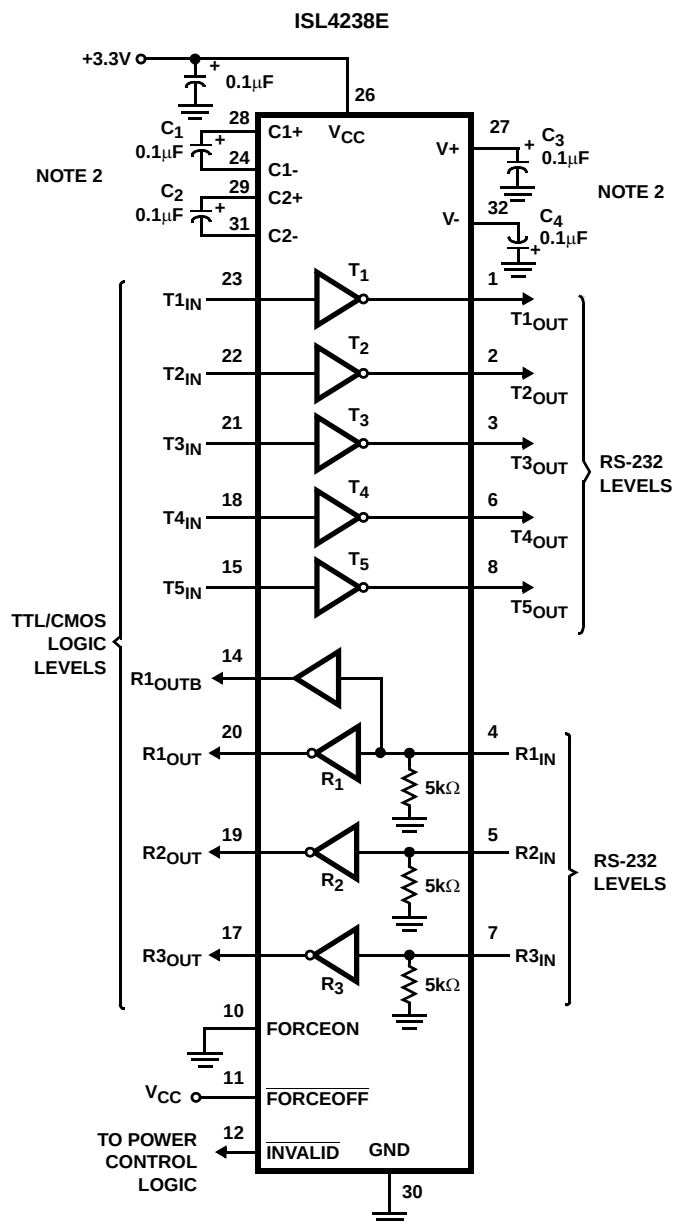
PIN	FUNCTION
V _{CC}	System power supply input (2.7V to 5.5V).
V+	Internally generated positive transmitter supply (+5.5V).
V-	Internally generated negative transmitter supply (-5.5V).
GND	Ground connection.
C1+	External capacitor (voltage doubler) is connected to this lead.
C1-	External capacitor (voltage doubler) is connected to this lead.
C2+	External capacitor (voltage inverter) is connected to this lead.
C2-	External capacitor (voltage inverter) is connected to this lead.
T _{IN}	TTL/CMOS compatible transmitter Inputs. (Note 1)
T _{OUT}	±15kV ESD Protected, RS-232 level (nominally ±5.5V) transmitter outputs.
R _{IN}	±15kV ESD Protected, RS-232 compatible receiver inputs.
R _{OUT}	TTL/CMOS level receiver outputs.
R _{OUTB}	TTL/CMOS level, noninverting, always enabled receiver outputs.
$\overline{\text{INVALID}}$	Active low output that indicates if no valid RS-232 levels are present on any receiver input.
$\overline{\text{FORCEOFF}}$	Active low to shut down transmitters and on-chip power supply. This overrides any automatic circuitry and FORCEON (see Table 2).
FORCEON	Active high input to override automatic powerdown circuitry thereby keeping transmitters active. ($\overline{\text{FORCEOFF}}$ must be high).

NOTE:

1. ISL4238E input pins incorporate positive feedback resistors. Once the input is driven to a valid logic level, the feedback resistor maintains that logic level until V_{CC} is removed. Unused transmitter inputs may be left unconnected by the user.

ISL4238E, ISL4244E, ISL4245E

Typical Operating Circuits

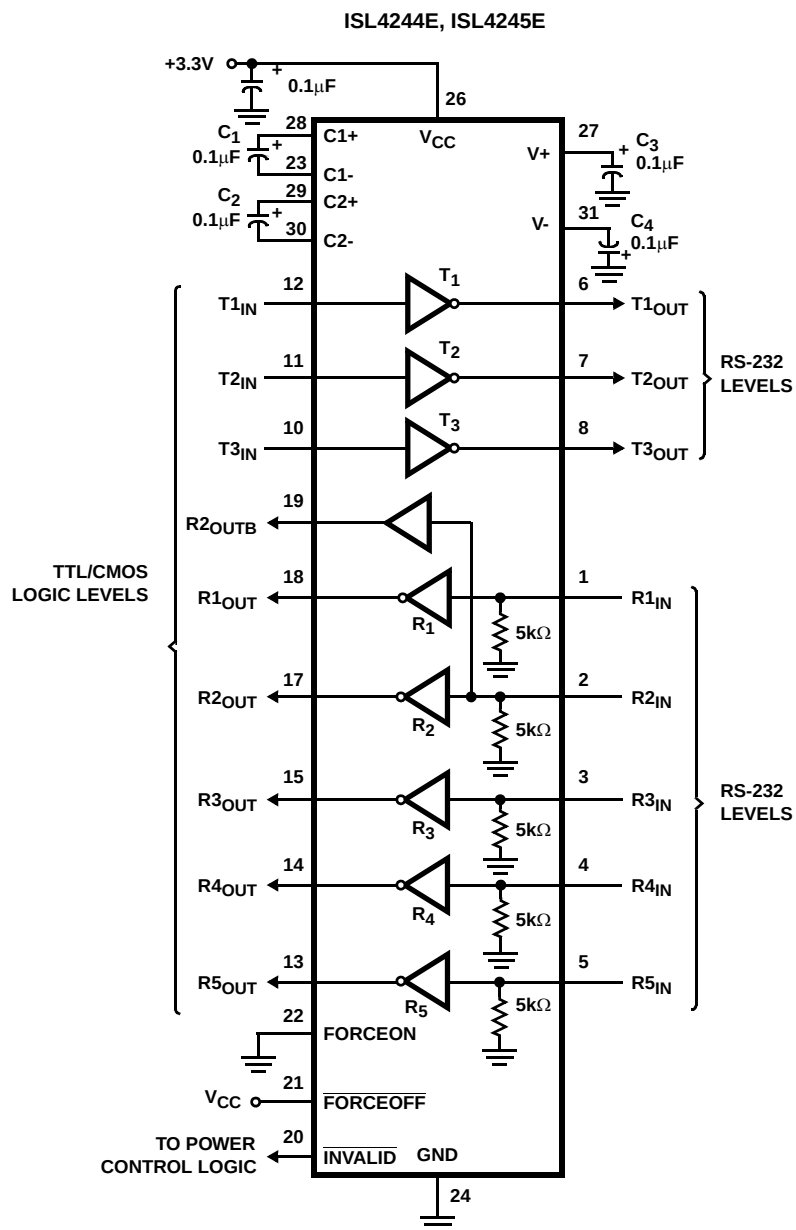


NOTE:

- For V_{CC} = 3.15V (3.3V -5%), use C₁ - C₄ = 0.1μF or greater. For V_{CC} = 3.0V (3.3V -10%), use C₁ - C₄ = 0.22μF or greater.

ISL4238E, ISL4244E, ISL4245E

Typical Operating Circuits (Continued)



ISL4238E, ISL4244E, ISL4245E

Absolute Maximum Ratings

V _{CC} to Ground	-0.3V to 6V
V+ to Ground	-0.3V to 7V
V- to Ground	+0.3V to -7V
V+ to V-	14V
Input Voltages	
T _{IN} , $\overline{\text{FORCEOFF}}$, FORCEON	-0.3V to 6V
R _{IN}	±25V
Output Voltages	
T _{OUT}	±13.2V
R _{OUT} , INVALID	-0.3V to V _{CC} +0.3V
Short Circuit Duration	
T _{OUT}	Continuous
ESD Rating	See Specification Table

Thermal Information

Thermal Resistance (Typical, Note 3)	θ_{JA} (°C/W)
32 Ld QFN Package	32
Moisture Sensitivity (see Technical Brief TB363)	
QFN Package	Level 1
Maximum Junction Temperature (Plastic Package)	150°C
Maximum Storage Temperature Range	-65°C to 150°C
Maximum Lead Temperature (Soldering 10s)	300°C

Operating Conditions

Temperature Range	
ISL42XXEIR	-40°C to 85°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

- θ_{JA} is measured in free air with the component mounted on a high effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379, and Tech Brief TB389.

Electrical Specifications Test Conditions: ISL4238E V_{CC} = 3.15V to 5.5V, C₁ - C₄ = 0.1μF; V_{CC} = 3V, C₁ - C₄ = 0.22μF; ISL424XE V_{CC} = 3V to 5.5V, C₁ - C₄ = 0.1μF; Unless Otherwise Specified. Typicals are at T_A = 25°C

PARAMETER	TEST CONDITIONS	TEMP (°C)	MIN	TYP	MAX	UNITS
DC CHARACTERISTICS						
Operating Voltage Range		Full	2.7	-	5.5	V
Supply Current, Automatic Powerdown	All R _{IN} Open, FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$	25	-	3	300	nA
		Full		50	300	nA
Supply Current, Powerdown	All R _{IN} Open, $\overline{\text{FORCEOFF}} = \text{GND}$	25	-	3	300	nA
		Full		50	300	nA
Supply Current, Automatic Powerdown Disabled	All Outputs Unloaded, FORCEON = $\overline{\text{FORCEOFF}} = V_{CC}$, V _{CC} = 3.0V	25	-	0.3	1.0	mA
		Full		0.3	1.5	mA
LOGIC AND TRANSMITTER INPUTS AND RECEIVER OUTPUTS						
Input Logic Threshold Low	T _{IN} , FORCEON, $\overline{\text{FORCEOFF}}$	Full	-	-	0.8	V
Input Logic Threshold High	T _{IN} , FORCEON, $\overline{\text{FORCEOFF}}$, V _{CC} = 3.6V	Full	2.0	-	-	V
Transmitter Input Hysteresis		25	-	0.5	-	V
Input Leakage Current	T _{IN} , FORCEON, $\overline{\text{FORCEOFF}}$ (ISL4238E, Note 4)	Full	-	±0.01	±1.0	μA
Output Leakage Current	$\overline{\text{FORCEOFF}} = \text{GND}$	Full	-	±0.05	±10	μA
Output Voltage Low	I _{OUT} = 1.6mA	Full	-	-	0.4	V
Output Voltage High	I _{OUT} = -1.0mA	Full	V _{CC} -0.6	V _{CC} -0.1	-	V
RECEIVER INPUTS						
Input Voltage Range		Full	-25	-	25	V
Input Threshold Low	V _{CC} = 3.0V	Full	-	1.0	0.6	V
Input Threshold High	V _{CC} = 3.6V	Full	2.4	1.5	-	V
Input Hysteresis		25	-	0.5	-	V
Input Resistance		Full	3	5	7	kΩ
TRANSMITTER OUTPUTS						
Output Voltage Swing	All Transmitter Outputs Loaded with 3kΩ to Ground	Full	±5.0	±5.4	-	V
Output Resistance	V _{CC} = V+ = V- = 0V, Transmitter Output = ±2V	Full	300	10M	-	Ω
Output Short-Circuit Current		Full	-	±35	±60	mA
Output Leakage Current	V _{OUT} = ±12V, V _{CC} = 0V or 3V to 5.5V, Automatic Powerdown or $\overline{\text{FORCEOFF}} = \text{GND}$	Full	-	-	±25	μA

ISL4238E, ISL4244E, ISL4245E

Electrical Specifications Test Conditions: ISL4238E $V_{CC} = 3.15V$ to $5.5V$, $C_1 - C_4 = 0.1\mu F$; $V_{CC} = 3V$, $C_1 - C_4 = 0.22\mu F$;
ISL424XE $V_{CC} = 3V$ to $5.5V$, $C_1 - C_4 = 0.1\mu F$; Unless Otherwise Specified. Typicals are at $T_A = 25^\circ C$

PARAMETER	TEST CONDITIONS		TEMP (°C)	MIN	TYP	MAX	UNITS
ENHANCED AUTOMATIC POWERDOWN (FORCEON = GND, FORCEOFF = V _{CC})							
Receiver Input Thresholds to INVALID High	See Figure 6		Full	-2.7	-	2.7	V
Receiver Input Thresholds to INVALID Low	See Figure 6		Full	-0.3	-	0.3	V
INVALID, Output Voltage Low	I _{OUT} = 1.6mA		Full	-	-	0.4	V
INVALID, Output Voltage High	I _{OUT} = -1.0mA		Full	V _{CC} -0.6	-	-	V
Receiver Positive or Negative Threshold to INVALID High Delay (t _{INVH})			25	-	0.5	1	μs
			Full	-	0.9	1.5	μs
Receiver Positive or Negative Threshold to INVALID Low Delay (t _{INVL})	ISL4238E		25	-	60	100	μs
			Full		100	150	μs
Receiver Positive or Negative Threshold to INVALID Low Delay (t _{INVL})	ISL4244E/45E		25	-	30	50	μs
			Full		40	60	μs
Receiver or Transmitter Edge to Transmitters Enabled Delay (t _{WU})	Note 5		Full	-	20	100	μs
Receiver or Transmitter Edge to Transmitters Disabled Delay (t _{AUTOPWDN})	Note 5		Full	15	30	60	sec
TIMING CHARACTERISTICS							
Maximum Data Rate ISL4238E/44E	R _L = 3kΩ, C _L = 1000pF, One Transmitter Switching		Full	250	500	-	kbps
Maximum Data Rate ISL4245E	R _L = 3kΩ, One Transmitter Switching	C _L = 1000pF	Full	250	900	-	kbps
		V _{CC} = 3V to 4.5V, C _L = 250pF	Full	1000	2000	-	kbps
		V _{CC} = 4.5V to 5.5V, C _L = 1000pF	Full	1000	1500	-	kbps
Receiver Propagation Delay	Receiver Input to Receiver Output, C _L = 150pF	t _{PHL}	25	-	0.15	0.3	μs
			Full	-	0.2	0.35	μs
		t _{PLH}	25	-	0.3	0.5	μs
			Full	-	0.35	0.55	μs
Receiver Skew	t _{PHL} - t _{PLH} , C _L = 150pF		25	-	120	250	ns
			Full	-	150	300	ns
Transmitter Propagation Delay ISL4238E/44E	Transmitter Input to Transmitter Output, C _L = 1000pF, R _L = 3kΩ	t _{PHL}	25	-	0.75	1	μs
			Full	-	0.85	1.1	μs
		t _{PLH}	25	-	0.8	1	μs
			Full	-	0.9	1.1	μs
Transmitter Skew ISL4238E/44E	t _{PHL} - t _{PLH} (Note 7), R _L = 3kΩ, C _L = 1000pF		25	-	50	200	ns
			Full	-	100	250	ns
Transmitter Propagation Delay ISL4245E	Transmitter Input to Transmitter Output, C _L = 1000pF, R _L = 3kΩ	t _{PHL}	25	-	0.4	0.8	μs
			Full	-	0.5	0.8	μs
		t _{PLH}	25	-	0.35	0.7	μs
			Full	-	0.4	0.7	μs
Transmitter Skew ISL4245E	t _{PHL} - t _{PLH} (Note 6), R _L = 3kΩ, C _L = 1000pF		25	-	50	200	ns
			Full	-	60	250	ns

ISL4238E, ISL4244E, ISL4245E

Electrical Specifications

Test Conditions: ISL4238E $V_{CC} = 3.15V$ to $5.5V$, $C_1 - C_4 = 0.1\mu F$; $V_{CC} = 3V$, $C_1 - C_4 = 0.22\mu F$;
ISL424XE $V_{CC} = 3V$ to $5.5V$, $C_1 - C_4 = 0.1\mu F$; Unless Otherwise Specified. Typical values are at $T_A = 25^\circ C$

PARAMETER	TEST CONDITIONS		TEMP (°C)	MIN	TYP	MAX	UNITS
Receiver Output Enable Time	Normal Operation, R _L = 1kΩ to 0.5V _{CC} , C _L = 15pF		25	-	200	350	ns
			Full	-	200	400	ns
Receiver Output Disable Time	Normal Operation, R _L = 1kΩ to 0.5V _{CC} , C _L = 15pF		25	-	350	500	ns
			Full	-	400	600	ns
Transmitter Output Enable Time ISL4238E/44E/45E	Normal Operation, R _L = 3kΩ, C _L = 1000pF		25	-	25	40	μs
			Full	-	35	50	μs
Transmitter Output Disable Time ISL4238E/44E/45E	Normal Operation, R _L = 3kΩ, C _L = 1000pF		25	-	2.5	4	μs
			Full	-	2.7	4	μs
Transition Region Slew Rate ISL4238E/44E	V _{CC} = 3V to 3.6V, R _L = 3kΩ to 7kΩ, Measured From 3V to -3V or -3V to 3V	C _L = 150pF to 1000pF	25	6	11	30	V/μs
			Full	6	10	30	V/μs
		C _L = 150pF to 2500pF	25	4	9	30	V/μs
			Full	4	8	30	V/μs
Transition Region Slew Rate ISL4245E	V _{CC} = 3V to 3.6V, R _L = 3kΩ to 7kΩ, Measured From 3V to -3V or -3V to 3V, C _L = 150pF to 1000pF		25	24	40	150	V/μs
			Full	24	35	150	V/μs
ESD PERFORMANCE							
RS-232 Pins (T _{OUT} , R _{IN})	Human Body Model		25	-	±15	-	kV
	IEC6100-4-2 Air Gap Discharge		25	-	±15	-	kV
	IEC6100-4-2 Contact Discharge		25	-	±8	-	kV
All Other Pins	Human Body Model		25	-	±3	-	kV

NOTES:

- ISL4238E inputs utilize a positive feedback resistor. The input current is negligible when the input is at either supply rail.
- An "edge" is defined as a transition through the transmitter or receiver input thresholds.
- Skew is measured at the receiver input switching points (1.4V).
- Skew is measured at the transmitter zero crossing points.

Detailed Description

These interface ICs operate from a single +2.7V to +5.5V supply, guarantee a 250kbps (ISL4238E/44E) / 1Mbps (ISL4245E) minimum data rate, require only four small external 0.1 μF capacitors, feature low power consumption, and meet all EIA RS-232C and V.28 specifications. The circuit is divided into three sections: The charge pump, the transmitters, and the receivers.

Charge-Pump

Intersil's new RS-232 family utilizes regulated on-chip dual charge pumps as voltage doublers, and voltage inverters to generate $\pm 5.5V$ transmitter supplies from a V_{CC} supply as low as 3.0V. This allows these devices to maintain RS-232 compliant output levels over the $\pm 10\%$ tolerance range of 3.3V powered systems. The efficient on-chip power supplies require only four small, external 0.1 μF capacitors for the voltage doubler and inverter functions. The charge pumps operate discontinuously (i.e., they turn off as soon as the V_+ and V_- supplies are pumped up to the nominal values), resulting in significant power savings.

Transmitters

The transmitters are proprietary, low dropout, inverting drivers that translate TTL/CMOS inputs to EIA/TIA-232 output levels. Coupled with the on-chip $\pm 5.5V$ supplies, these transmitters deliver true RS-232 levels over a wide range of single supply system voltages.

Transmitter outputs disable and assume a high impedance state when the device enters the powerdown mode (see Table 2). These outputs may be driven to $\pm 12V$ when disabled.

The ISL4238E/44E guarantee a 250kbps data rate for full load conditions ($3k\Omega$ and $1000pF$), $V_{CC} \geq 3.0V$, with one transmitter operating at full speed. Under more typical conditions of $V_{CC} \geq 3.3V$, $R_L = 3k\Omega$, and $C_L = 250pF$, one transmitter easily operates at 1Mbps.

The ISL4245E guarantees a 1Mbps data rate for full load conditions ($3k\Omega$ and $250pF$), $V_{CC} \geq 3.0V$, with one transmitter operating at full speed. Under more typical conditions of $V_{CC} \geq 3.3V$, $R_L = 3k\Omega$, and $C_L = 250pF$, one transmitter easily operates at 1.4Mbps.

TABLE 2. POWERDOWN LOGIC TRUTH TABLE

8. Input is connected to $\overline{\text{INVALID}}$ Output.

V_{CC}
 R_{XIN}
 $-25V \leq V_{RIN} \leq +25V$
 GND
 $5k\Omega$
 R_{XOUT}
 $GND \leq V_{ROUT} \leq V_{CC}$

The ISL4238E4XE inverting receivers disable during forced (manual) powerdown, but not during automatic powerdown (see Table 2). Conversely, the monitor receiver remains active even during manual powerdown making it extremely useful for Ring Indicator monitoring. Standard receivers driving powered down peripherals must be disabled to

These 3V devices require a nominal supply current of 0.3mA, even at $V_{CC} = 5.5V$, during normal operation (not in powerdown mode). This is considerably less than the 5mA to 11mA current required by comparable 5V RS-232 devices, allowing users to reduce system power simply by switching to this new family.

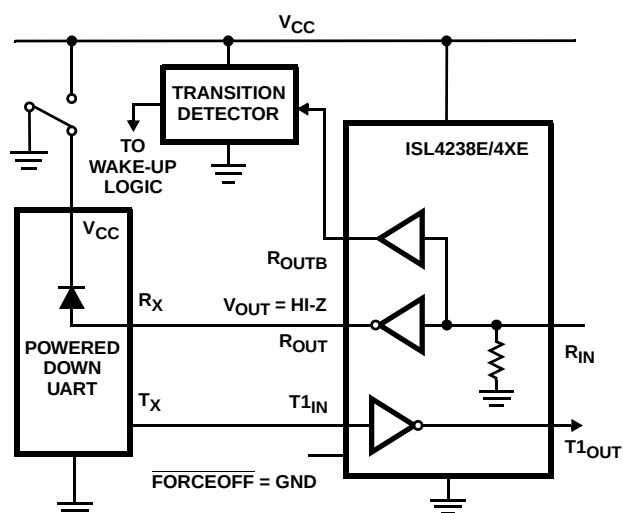


FIGURE 3. DISABLED RECEIVERS PREVENT POWER DRAIN

Powerdown Functionality

The already low current requirement drops significantly when the device enters powerdown mode. In powerdown, supply current drops to 10nA, because the on-chip charge pump turns off (V^+ collapses to V_{CC} , V^- collapses to GND), and the transmitter outputs tristate. Inverting receiver outputs disable only in manual powerdown; refer to Table 2 for details. This micro-power mode makes these devices ideal for battery powered and portable applications.

Software Controlled (Manual) Powerdown

These devices allow the user to force the IC into the low power, standby state, and utilize a two pin approach where the FORCEON and FORCEOFF inputs determine the IC's mode. For always enabled operation, FORCEON and FORCEOFF are both strapped high. To switch between active and powerdown modes, under logic or software control, only the FORCEOFF input need be driven. The FORCEON state isn't critical, as FORCEOFF dominates over FORCEON. Nevertheless, if strictly manual control over powerdown is desired, the user must strap FORCEON high to disable the enhanced automatic powerdown circuitry. ISL4238E/4XE inverting (standard) receiver outputs also disable when the device is in manual powerdown, thereby eliminating the possible current path through a shutdown peripheral's input protection diode (see Figures 2 and 3).

Connecting FORCEOFF and FORCEON together disables the enhanced automatic powerdown feature, enabling them to function as a manual SHUTDOWN input (see Figure 4).

With any of the above control schemes, the time required to exit powerdown, and resume transmission is only 100μs.

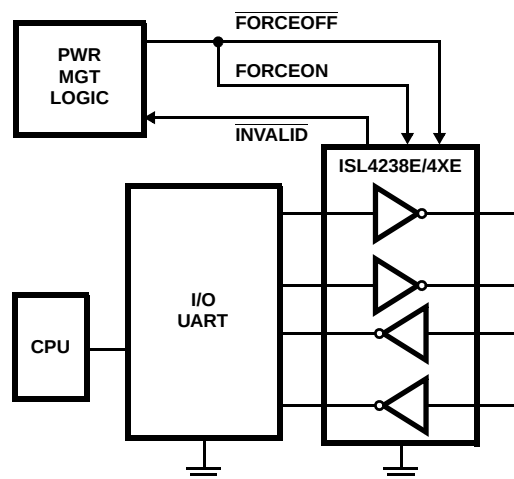


FIGURE 4. CONNECTIONS FOR MANUAL POWERDOWN WHEN NO VALID RECEIVER SIGNALS ARE PRESENT

When using both manual and enhanced automatic powerdown ($\text{FORCEON} = 0$), the ISL4238E/4XE won't power up from manual powerdown until both FORCEOFF and FORCEON are driven high, or until a transition occurs on a receiver or transmitter input. Figure 5 illustrates a circuit for ensuring that the ISL4238E/4XE powers up as soon as FORCEOFF switches high. The rising edge of the Master Powerdown signal forces the device to power up, and the ISL4238E/4XE returns to enhanced automatic powerdown mode an RC time constant after this rising edge. The time constant isn't critical, because the ISL4238E/4XE remains powered up for 30 seconds after the FORCEON falling edge, even if there are no signal transitions. This gives slow-to-wake systems (e.g., a mouse) plenty of time to start transmitting, and as long as it starts transmitting within 30 seconds both systems remain enabled.

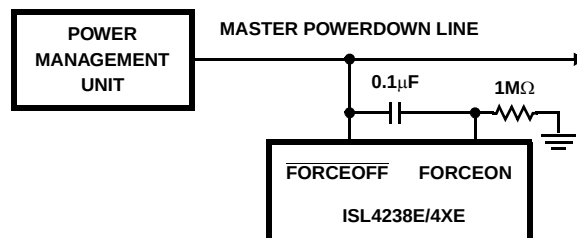


FIGURE 5. CIRCUIT TO ENSURE IMMEDIATE POWER UP WHEN EXITING FORCED POWERDOWN

INVALID Output

The INVALID output always indicates (see Table 2) whether or not 30μs have elapsed with invalid RS-232 signals (see Figures 6 and 9) persisting on all of the receiver inputs, giving the user an easy way to determine when the interface block should power down. Invalid receiver levels occur whenever the driving peripheral's outputs are shut off (powered down) or when the RS-232 interface cable is disconnected. In the case of a disconnected interface cable where all the receiver inputs are floating (but pulled to GND

by the internal receiver pull down resistors), the $\overline{\text{INVALID}}$ logic detects the invalid levels and drives the output low. The power management logic then uses this indicator to power down the interface block. Reconnecting the cable restores valid levels at the receiver inputs, $\overline{\text{INVALID}}$ switches high, and the power management logic wakes up the interface block. $\overline{\text{INVALID}}$ can also be used to indicate the DTR or RING INDICATOR signal, as long as the other receiver inputs are floating, or driven to GND (as in the case of a powered down driver).

$\overline{\text{INVALID}}$ switches high $1\mu\text{s}$ after detecting a valid RS-232 level on a receiver input. $\overline{\text{INVALID}}$ operates in all modes (forced or automatic powerdown, or forced on), so it is also useful for systems employing manual powerdown circuitry.

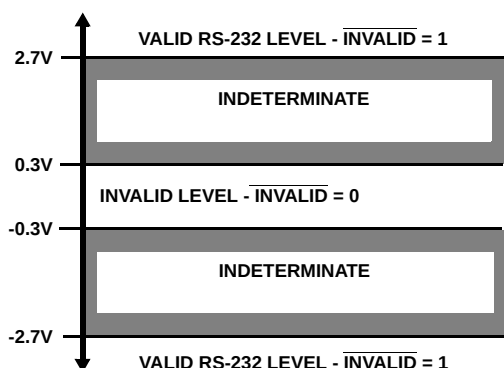


FIGURE 6. DEFINITION OF VALID RS-232 RECEIVER LEVELS
Enhanced Automatic Powerdown

Even greater power savings is available by using these devices which feature an *enhanced automatic* powerdown function. When the enhanced powerdown logic determines that no transitions have occurred on any of the transmitter nor receiver inputs for 30 seconds, the charge pump and transmitters powerdown, thereby reducing supply current to 10nA. The ISL4238E/4XE automatically powers back up whenever it detects a transition on one of these inputs. This automatic powerdown feature provides additional system power savings without changes to the existing operating system.

Enhanced automatic powerdown operates when the FORCEON input is low, and the $\overline{\text{FORCEOFF}}$ input is high. Tying FORCEON high disables automatic powerdown, but manual powerdown is always available via the overriding $\overline{\text{FORCEOFF}}$ input. Table 2 summarizes the enhanced automatic powerdown functionality.

Figure 7 illustrates the enhanced powerdown control logic. Note that once the ISL4238E/4XE enters powerdown (manually or automatically), the 30 second timer remains timed out (set), keeping the ISL4238E/4XE powered down until FORCEON transitions high, or until a transition occurs on a receiver or transmitter input.

The $\overline{\text{INVALID}}$ output signal switches low to indicate that invalid levels have persisted on all of the receiver inputs for more than $30\mu\text{s}$ (see Figure 9), but this has no direct effect

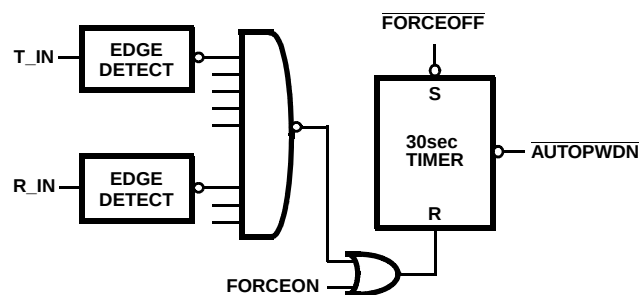


FIGURE 7. ENHANCED AUTOMATIC POWERDOWN LOGIC
on the state of the ISL4238E/4XE (see the next sections for methods of utilizing $\overline{\text{INVALID}}$ to power down the device).

The time to recover from automatic powerdown mode is typically $100\mu\text{s}$.

Emulating Standard Automatic Powerdown

If enhanced automatic powerdown isn't desired, the user can implement the standard automatic powerdown feature (mimics the function on the ISL4243E) by connecting the $\overline{\text{INVALID}}$ output to the FORCEON and $\overline{\text{FORCEOFF}}$ inputs, as shown in Figure 8. After $30\mu\text{s}$ of invalid receiver levels, $\overline{\text{INVALID}}$ switches low and drives the ISL4238E/4XE into a forced powerdown condition. $\overline{\text{INVALID}}$ switches high as soon as a receiver input senses a valid RS-232 level, forcing the ISL4238E/4XE to power on. See the "INVALID DRIVING FORCEON AND $\overline{\text{FORCEOFF}}$ " section of Table 2 for an operational summary. This operational mode is perfect for handheld devices that communicate with another computer via a detachable cable. Detaching the cable allows the internal receiver pull-down resistors to pull the inputs to GND (an invalid RS-232 level), causing the $30\mu\text{s}$ timer to time-out and drive the IC into powerdown. Reconnecting the cable restores valid levels, causing the IC to power back up.

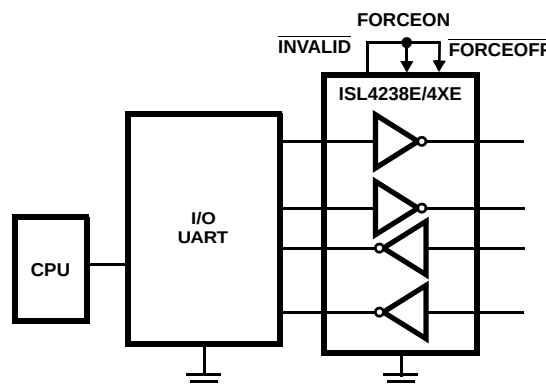


FIGURE 8. CONNECTIONS FOR AUTOMATIC POWERDOWN WHEN NO VALID RECEIVER SIGNALS ARE PRESENT

Hybrid Automatic Powerdown Options

For devices which communicate only through a detachable cable, connecting $\overline{\text{INVALID}}$ to $\overline{\text{FORCEOFF}}$ (with $\text{FORCEON} = 0$) may be a desirable configuration. While the

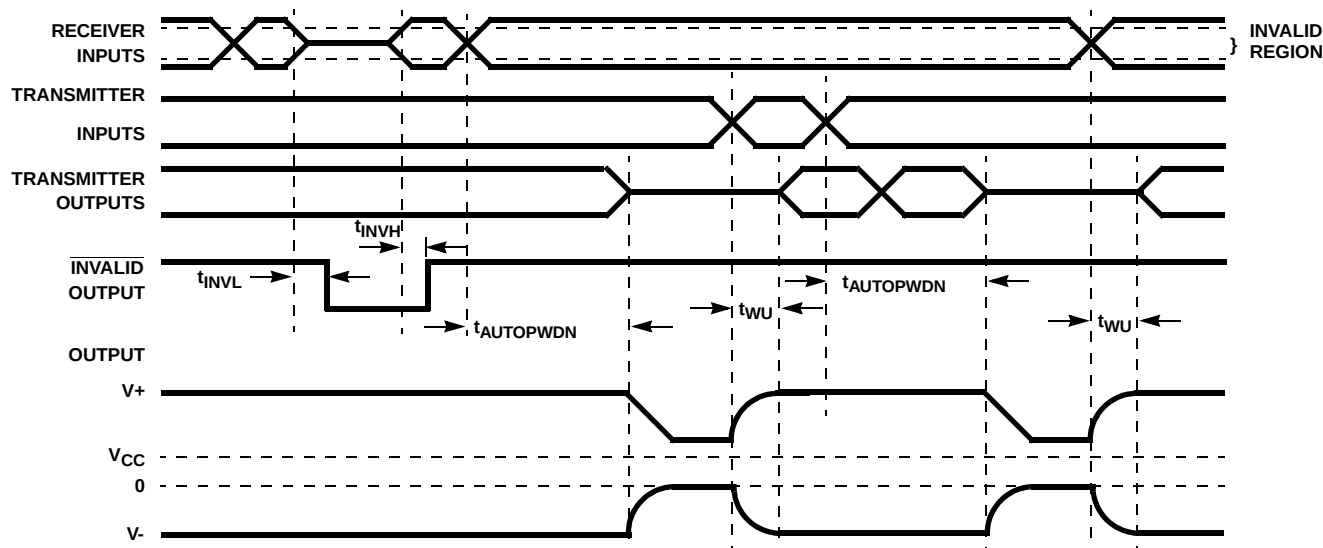


FIGURE 9. ENHANCED AUTOMATIC POWERDOWN AND INVALID TIMING DIAGRAMS

cable is attached $\overline{\text{INVALID}}$ and $\overline{\text{FORCEOFF}}$ remain high, so the enhanced automatic powerdown logic powers down the RS-232 device whenever there is 30 seconds of inactivity on the receiver and transmitter inputs. Detaching the cable allows the receiver inputs to drop to an invalid level (GND), so $\overline{\text{INVALID}}$ switches low and forces the RS-232 device to power down. The ISL4238E/4XE remains powered down until the cable is reconnected ($\overline{\text{INVALID}} = \overline{\text{FORCEOFF}} = 1$) and a transition occurs on a receiver or transmitter input (see Figure 7). For immediate power up when the cable is reattached, connect $\overline{\text{FORCEON}}$ to $\overline{\text{FORCEOFF}}$ through a network similar to that shown in Figure 5.

Capacitor Selection

The ISL4238E charge pumps require 0.1 μF , or greater, capacitors for 3.3V (5% tolerance) operation. For other supply voltages refer to Table 3 for capacitor values. Do not use values smaller than those listed in Table 3.

TABLE 3. REQUIRED CAPACITOR VALUES (ISL4238E)

V _{CC} (V)	C ₁ (μF)	C ₂ , C ₃ , C ₄ (μF)
3.0 to 3.6 (3.3V $\pm 10\%$)	0.22	0.22
3.15 to 3.6 (3.3V $\pm 5\%$)	0.1	0.1
4.5 to 5.5	0.047	0.33
3.0 to 5.5	0.22	1

The ISL4244E/45E charge pumps require 0.1 μF capacitors for proper operation. Increasing the capacitor values (by a factor of 2) reduces ripple on the transmitter outputs and slightly reduces power consumption. C₂, C₃, and C₄ can be increased without increasing C₁'s value, however, do not increase C₁ without also increasing C₂, C₃, and C₄ to maintain the proper ratios (C₁ to the other capacitors).

When using minimum required capacitor values, make sure that capacitor values do not degrade excessively with temperature. If in doubt, use capacitors with a larger nominal value. The capacitor's equivalent series resistance (ESR) usually rises at low temperatures and it influences the amount of ripple on V₊ and V₋.

Power Supply Decoupling

In most circumstances a 0.1 μF bypass capacitor is adequate. In applications that are particularly sensitive to power supply noise, decouple V_{CC} to ground with a capacitor of the same value as the charge-pump capacitor C₁. Connect the bypass capacitor as close as possible to the IC.

Transmitter Outputs when Exiting Powerdown

Figure 10 shows the response of two transmitter outputs when exiting powerdown mode. As they activate, the two transmitter outputs properly go to opposite RS-232 levels, with no glitching, ringing, nor undesirable transients. Each transmitter is loaded with 3k Ω in parallel with 2500pF. Note that the transmitters enable only when the magnitude of the supplies exceed approximately 3V.

Operation Down to 2.7V

ISL4238E/4XE transmitter outputs meet RS-562 levels ($\pm 3.7\text{V}$), at the full data rate, with V_{CC} as low as 2.7V. RS-562 levels typically ensure interoperability with RS-232 devices.

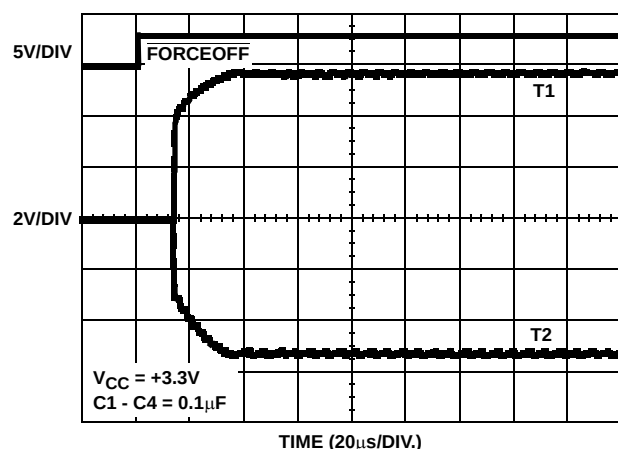


FIGURE 10. TRANSMITTER OUTPUTS WHEN EXITING POWERDOWN

Mouse Driveability

The ISL424XE are specifically designed to power a serial mouse while operating from low voltage supplies. Figure 11 shows the transmitter output voltages under increasing load current. The on-chip switching regulator ensures the transmitters will supply at least $\pm 5V$ during worst case conditions (15mA for paralleled V+ transmitters, 7.3mA for single V- transmitter).

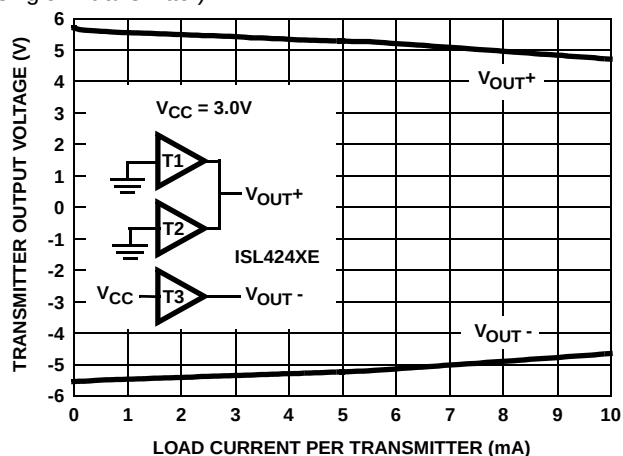


FIGURE 11. TRANSMITTER OUTPUT VOLTAGE vs LOAD CURRENT (PER TRANSMITTER, i.e., DOUBLE CURRENT AXIS FOR TOTAL V_{OUT+} CURRENT)

High Data Rates

The ISL4238E/4XE maintain the RS-232 $\pm 5V$ minimum transmitter output voltages even at high data rates. Figure 12 details a transmitter loopback test circuit, and Figure 13 illustrates the ISL4238E/44E loopback test result at 120kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 120kbps. Figure 14 shows the ISL4238E/44E loopback results for a single transmitter driving 1000pF and an RS-232 load at 250kbps. Figure 15 illustrates the ISL4245E loopback test result at 250kbps. For this test, all transmitters were simultaneously driving RS-232 loads in parallel with 1000pF, at 250kbps. Figure 16 shows the ISL4245E loopback results

for a single transmitter driving 250pF and an RS-232 load at 1Mbps. The static transmitters were also loaded with an RS-232 receiver.

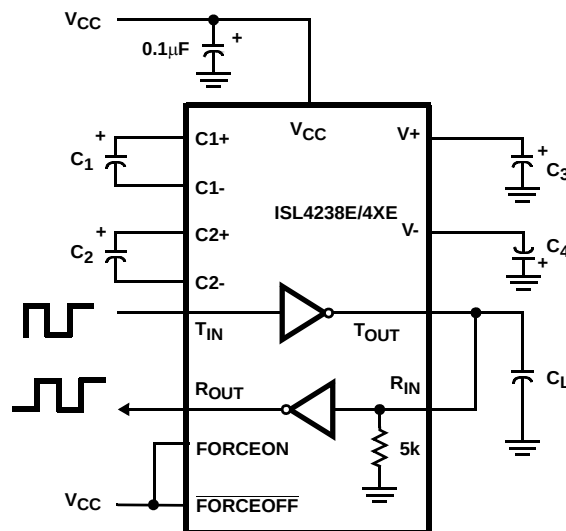


FIGURE 12. TRANSMITTER LOOPBACK TEST CIRCUIT

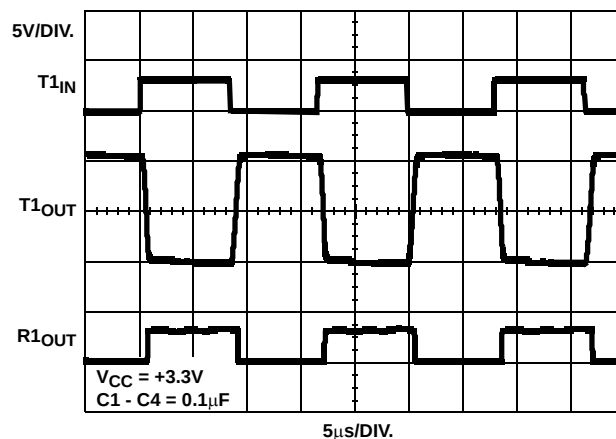


FIGURE 13. ISL4238E/44E LOOPBACK TEST AT 120kbps

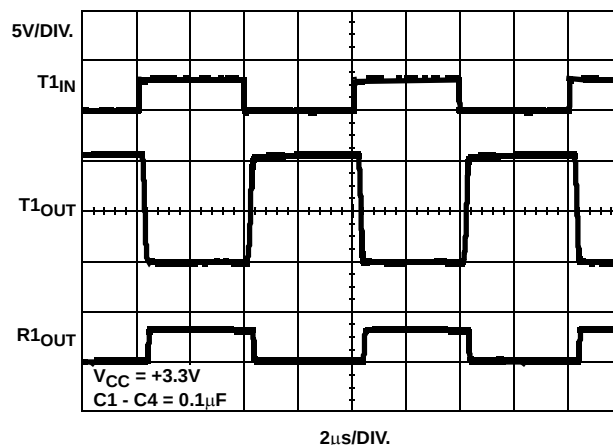


FIGURE 14. ISL4238E/44E LOOPBACK TEST AT 250kbps ($C_L = 1000pF$)

ISL4238E, ISL4244E, ISL4245E

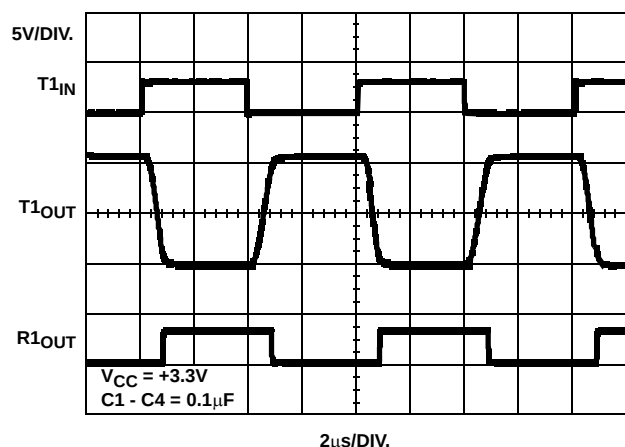


FIGURE 15. ISL4245E LOOPBACK TEST AT 250kbps

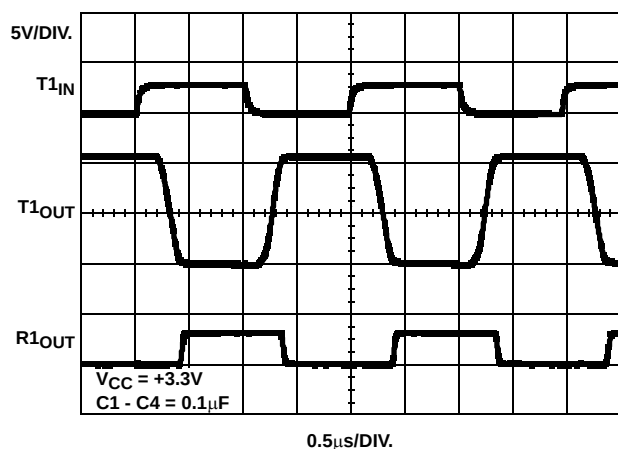


FIGURE 16. ISL4245E LOOPBACK TEST AT 1Mbps
($C_L = 250\text{pF}$)

Interconnection with 3V and 5V Logic

The ISL4238E/4XE directly interface with 5V CMOS and TTL logic families. Nevertheless, with the ISL4238E/4XE at 3.3V, and the logic supply at 5V, AC, HC, and CD4000 outputs can drive ISL4238E/4XE inputs, but ISL4238E/4XE outputs do not reach the minimum V_{IH} for these logic families. See Table 4 for more information.

TABLE 4. LOGIC FAMILY COMPATIBILITY WITH VARIOUS SUPPLY VOLTAGES

SYSTEM POWER-SUPPLY VOLTAGE (V)	V _{CC} SUPPLY VOLTAGE (V)	COMPATIBILITY
3.3	3.3	Compatible with all CMOS families.
5	5	Compatible with all TTL and CMOS logic families.
5	3.3	Compatible with ACT and HCT CMOS, and with TTL. ISL4238E/4XE outputs are incompatible with AC, HC, and CD4000 CMOS inputs.

±15kV ESD Protection

All pins on ISL4238E/4XE devices include ESD protection structures, but the RS-232 pins (transmitter outputs and receiver inputs) incorporate advanced structures which allow them to survive ESD events up to ±15kV. The RS-232 pins are particularly vulnerable to ESD damage because they typically connect to an exposed port on the exterior of the finished product. Simply touching the port pins, or connecting a cable, can cause an ESD event that might destroy unprotected ICs. These new ESD structures protect the device whether or not it is powered up, protect without allowing any latchup mechanism to activate, and don't interfere with RS-232 signals as large as ±25V.

Human Body Model (HBM) Testing

As the name implies, this test method emulates the ESD event delivered to an IC during human handling. The tester delivers the charge through a 1.5kΩ current limiting resistor, making the test less severe than the IEC6100 test which utilizes a 330Ω limiting resistor. The HBM method determines an IC's ability to withstand the ESD transients typically present during handling and manufacturing. Due to the random nature of these events, each pin is tested with respect to all other pins. The RS-232 pins on "E" family devices can withstand HBM ESD events to ±15kV.

IEC6100-4-2 Testing

The IEC6100 test method applies to finished equipment, rather than to an individual IC. Therefore, the pins most likely to suffer an ESD event are those that are exposed to the outside world (the RS-232 pins in this case), and the IC is tested in its typical application configuration (power applied) rather than testing each pin-to-pin combination. The lower current limiting resistor coupled with the larger charge storage capacitor yields a test that is much more severe than the HBM test. The extra ESD protection built into this device's RS-232 pins allows the design of equipment meeting level 4 criteria without the need for additional board level protection on the RS-232 port.

ISL4238E, ISL4244E, ISL4245E

AIR-GAP DISCHARGE TEST METHOD

For this test method, a charged probe tip moves toward the IC pin until the voltage arcs to it. The current waveform delivered to the IC pin depends on approach speed, humidity, temperature, etc., so it is difficult to obtain repeatable results. The “E” device RS-232 pins withstand $\pm 15\text{kV}$ air-gap discharges.

CONTACT DISCHARGE TEST METHOD

During the contact discharge test, the probe contacts the tested pin before the probe tip is energized, thereby eliminating the variables associated with the air-gap discharge. The result is a more repeatable and predictable test, but equipment limits prevent testing devices at voltages higher than $\pm 8\text{kV}$. All “E” family devices survive $\pm 8\text{kV}$ contact discharges on the RS-232 pins.

Typical Performance Curves $V_{CC} = 3.3\text{V}$, $T_A = 25^\circ\text{C}$

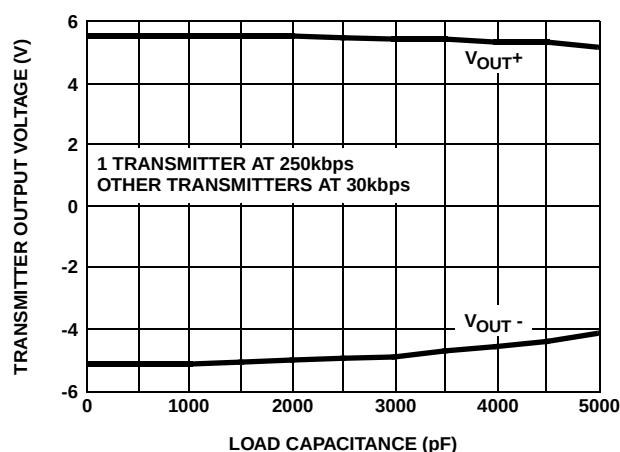


FIGURE 17. ISL4238E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

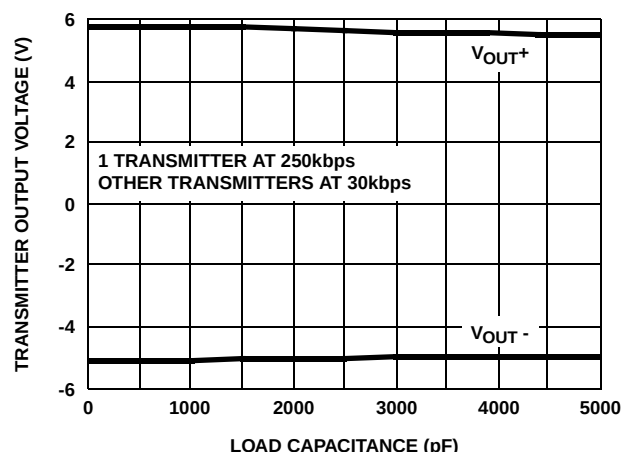


FIGURE 18. ISL4244E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

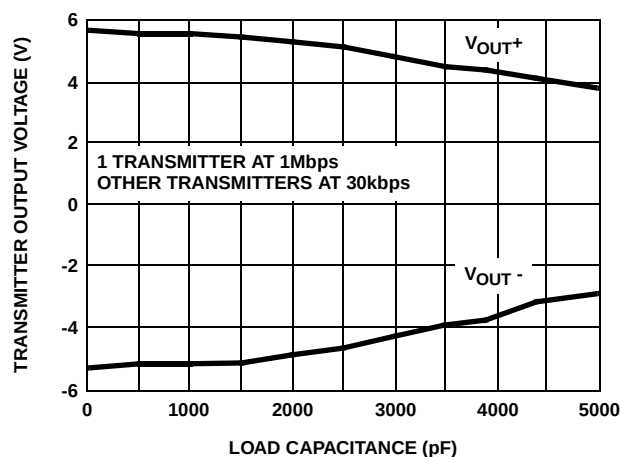


FIGURE 19. ISL4245E TRANSMITTER OUTPUT VOLTAGE vs LOAD CAPACITANCE

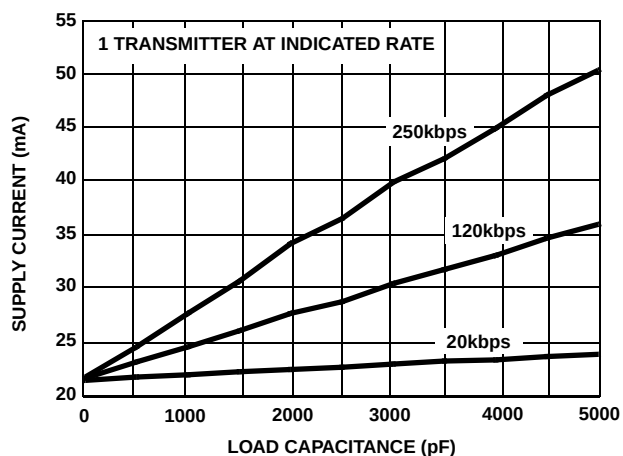


FIGURE 20. ISL4238E SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

ISL4238E, ISL4244E, ISL4245E

Typical Performance Curves $V_{CC} = 3.3V$, $T_A = 25^\circ C$ (Continued)

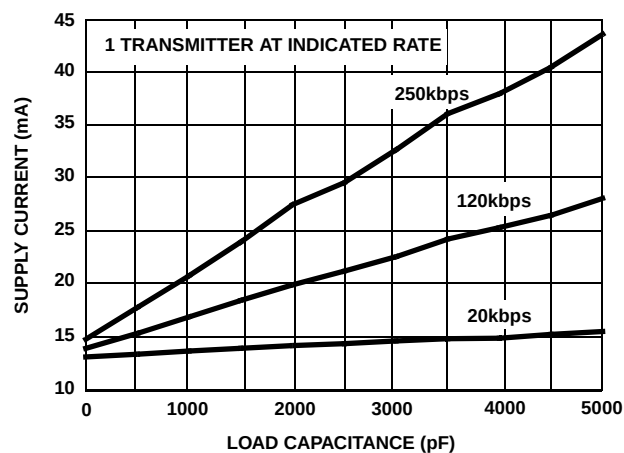


FIGURE 21. ISL4244E SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

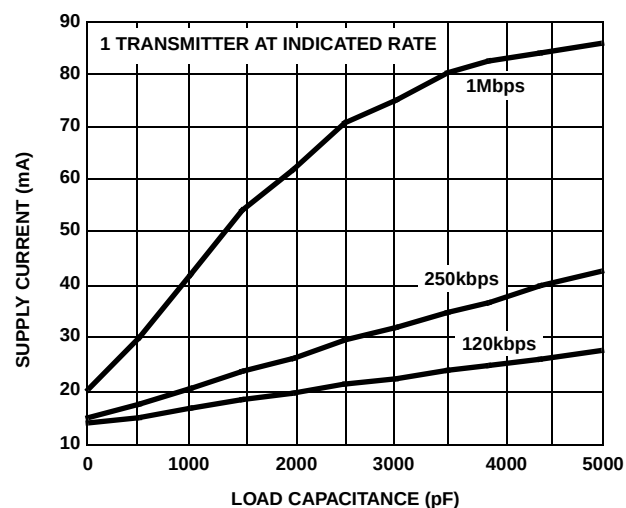


FIGURE 22. ISL4245E SUPPLY CURRENT vs LOAD CAPACITANCE WHEN TRANSMITTING DATA

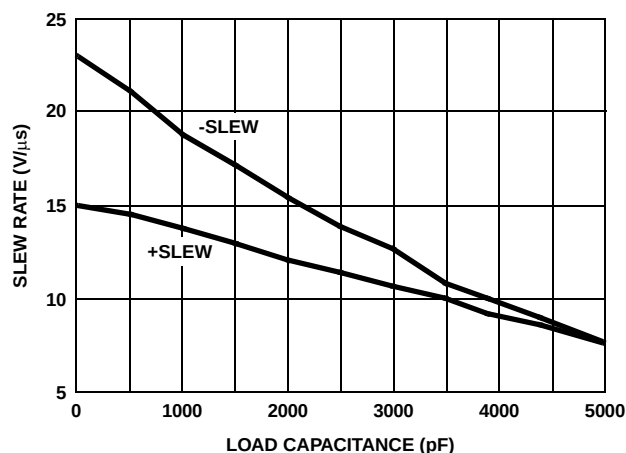


FIGURE 23. ISL4238E/44E SLEW RATE vs LOAD CAPACITANCE

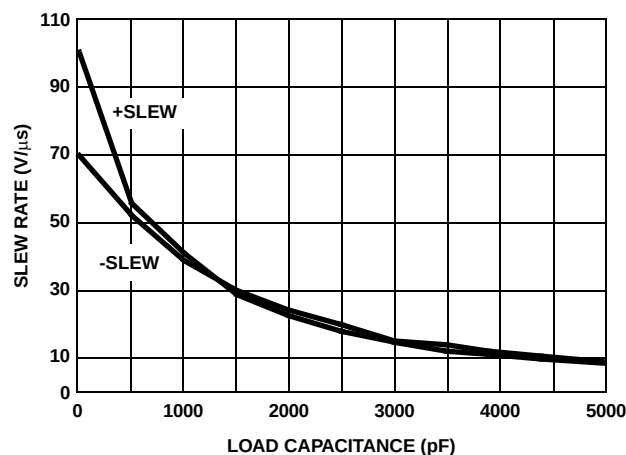


FIGURE 24. ISL4245E SLEW RATE vs LOAD CAPACITANCE

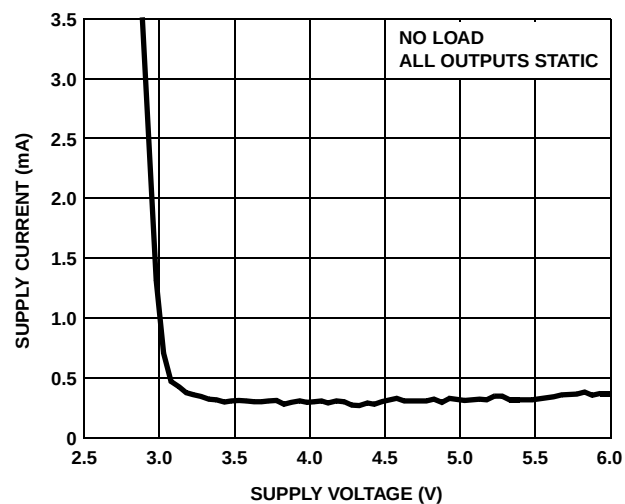


FIGURE 25. SUPPLY CURRENT vs SUPPLY VOLTAGE

Die Characteristics

SUBSTRATE POTENTIAL (POWERED UP)

GND

TRANSISTOR COUNT

ISL4238E: 1235

ISL4244E: 1109

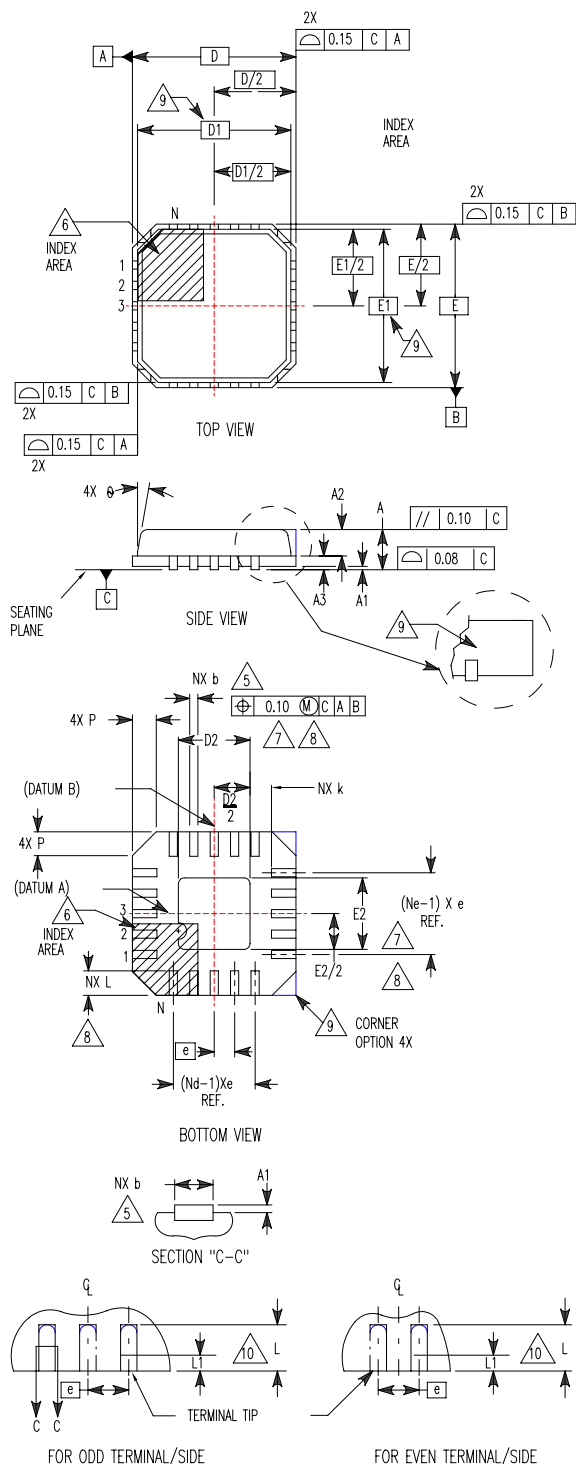
ISL4245E: 1109

PROCESS

Si Gate CMOS

ISL4238E, ISL4244E, ISL4245E

Quad Flat No-Lead Plastic Package (QFN) Micro Lead Frame Plastic Package (MLFP)



L32.5x5

32 LEAD QUAD FLAT NO-LEAD PLASTIC PACKAGE
(COMPLIANT TO JEDEC MO-220VHHD-2 ISSUE C)

SYMBOL	MILLIMETERS			NOTES
	MIN	NOMINAL	MAX	
A	0.80	0.90	1.00	-
A1	-	-	0.05	-
A2	-	-	1.00	9
A3	0.20 REF			9
b	0.18	0.23	0.30	5,8
D	5.00 BSC			-
D1	4.75 BSC			9
D2	2.95	3.10	3.25	7,8
E	5.00 BSC			-
E1	4.75 BSC			9
E2	2.95	3.10	3.25	7,8
e	0.50 BSC			-
k	0.25	-	-	-
L	0.30	0.40	0.50	8
L1	-	-	0.15	10
N	32			2
Nd	8			3
Ne	8	8		3
P	-	-	0.60	9
θ	-	-	12	9

Rev. 1 10/02

NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. N is the number of terminals.
3. Nd and Ne refer to the number of terminals on each D and E.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
7. Dimensions D2 and E2 are for the exposed pads which provide improved electrical and thermal performance.
8. Nominal dimensions are provided to assist with PCB Land Pattern Design efforts, see Intersil Technical Brief TB389.
9. Features and dimensions A2, A3, D1, E1, P & θ are present when Anvil singulation method is used and not present for saw singulation.
10. Depending on the method of lead termination at the edge of the package, a maximum 0.15mm pull back (L1) maybe present. L minus L1 to be equal to or greater than 0.3mm.

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